

TEA6417

BUS-CONTROLLED VIDEO MATRIX SWITCH

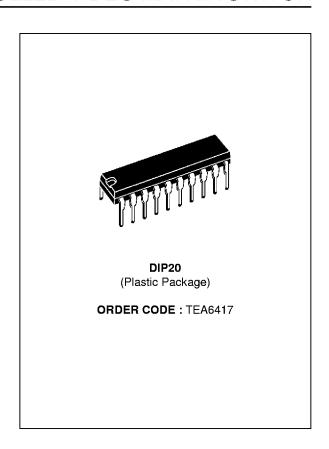
- 15MHz BANDWIDTH
- CASCADABLE WITH ANOTHER TEA6417 (INTERNAL ADDRESS CAN BE CHANGED BY PIN 7 VOLTAGE)
- 8 INPUTS (CVBS, RGB, MAC, CHROMA...)
- 6 OUTPUTS
- POSSIBILITY OF MAC OR CHROMA SIGNAL FOR EACH INPUT BY SWITCHING-OFF THE CLAMP WITH AN EXTERNAL RESISTOR BRIDGE
- BUS CONTROLLED
- 6.5dB GAIN BETWEEN ANY INPUT AND OUTPUT
- - 60dB CROSSTALK AT 3.58MHz
- FULLY ESD PROTECTED

DESCRIPTION

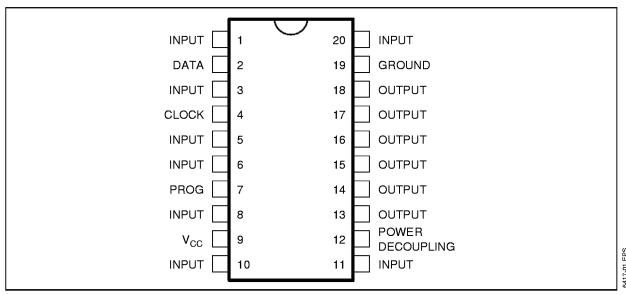
The main function of the TEA6417 is to switch 8 video input sources on the 6 outputs.

Each output can be switched to only one of the inputs whereas but any same input may be connected to several outputs.

All the switching possibilities are controlled through the I²C Bus.

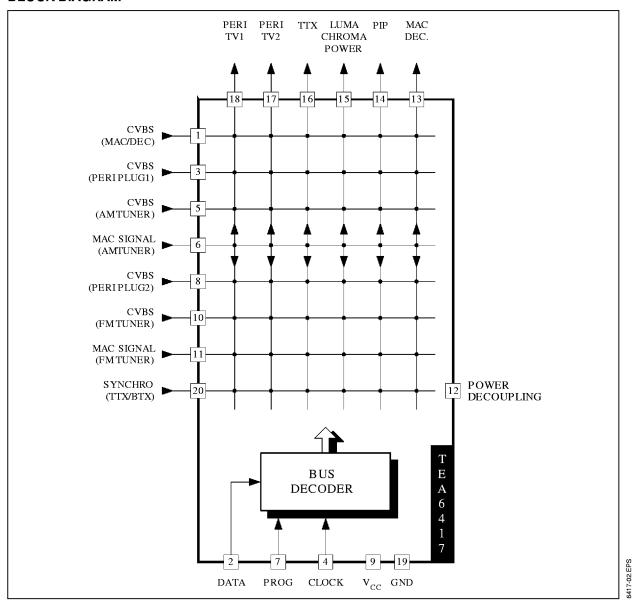


PIN CONNECTIONS



May 1996 1/7

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage (Pin 9)	13	V
T _A	Operating Ambient Temperature Range	0 to +70	°C
T _{stg}	Storage Temperature Range	-20 to +150	°C

THERMAL DATA

Symbol	Parameter	Value	Unit	Ē
R _{th(j-a)}	Junction-Ambient Thermal Resistance	80	°C/W	1

ELECTRICAL CHARACTERISTICS

 $T_A = 25^{\circ}C$, $V_{CC} = 10V$, $R_{LOAD} = 10k\Omega$, $C_{LOAD} = 3pF$ (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage (Pin 9)	8	10	11	V
Icc	Power Supply Current (without load on outputs; V _{CC} =10V)	20	30	40	mA

INPUTS

	Maximum Signal Amplitude (CVBS signal)	2			V_{PP}	
	Input Current (per output connected, input voltage = $5V_{DC}$) (this current is X6 when all outputs are connected on the input)		1	3	μΑ	
	DC Level	2.8	3.1	3.4	٧	ĺ

OUTPUTS (V_{IN} = 1 V_{PP} for all dynamic tests) Pins 13 - 14 - 15 - 16 - 17 - 18

Dynamic	4	4.8		V _{PP}
Output Impedance		25	50	Ω
Gain	5.5	6.5	7.5	dB
Bandwidth -1dB attenuation -3dB attenuation	7	10 15		MHz MHz
Crosstalk f = 3.58MHz f = 5MHz		-60 -55	-50	dB dB
DC level	3.3	3.6	3.9	V

I²C BUS INPUT : DATA, CLOCK, PROG (Pins 2 - 4 - 7)

 , , , , , , , , , , , , , , , , , , ,					. 6
Threshold Voltage	1.5	2	з	٧	2417

6417-03.TBL

GENERAL DESCRIPTION

The main function of the IC is to switch 8 video input sources on 6 outputs.

Each output can be switched on only one of each input. On each input an alignment of the lowest level of the signal is made (bottom of synch. top for CVBS or black level for RGB signals).

Each nominal gain between any input and output is 6.5dB. For D2MAC or Chroma signal the alignment is switched off by forcing, with an external resistor bridge, 5 V_{DC} on the input.Each input can be used as a normal input or as a MAC or Chroma

input (with external resistor bridge). All the switching possibilities are changed through the BUS.

Driving 75 Ω load needs an external transistor. It is possible to have the same input connected to several outputs.

The starting configuration upon power on (power supply: 0 to 10V) is undetermined.

In this case, 6 words of 16 bits are necessary to determine one configuration. In other case, 1 word of 16 bits is necessary to determine one configuration.

BUS SELECTIONS (I²C-BUS)

2 nd byte of transmission

ADDRESS MSB	DATA LSB	Selected Output	
00000 00100 00010 00110 00001 00101	XXX XXX XXX XXX XXX	pin 18 pin 14 pin 16 Not used pin 17 pin13	Output is selected by address bits
00011 000111	XXX	pin 15 Not used Selected Input	
00XXX 00XXX 00XXX 00XXX 00XXX 00XXX 00XXX	000 100 010 110 001 101 011	pin 5 pin 8 pin 3 pin 20 pin 6 pin 10 pin 1 pin 11	Input is selected by data bits

Example:00100 101 connects pin 10 (input) to pin 14 (output) (equals 25 in hexadecimal) Adress byte (1st byte of transmission)

96	1001	0110
92	1001	0010

When pin PROG is connected to ground When pin PROG is connected to V_{CC}

IN / OUT PIN CONFIGURATION

Figure 1: Input Configuration

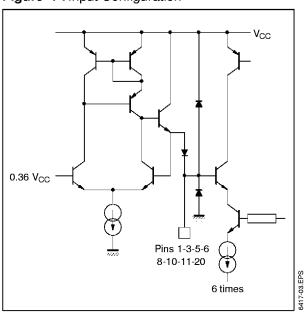
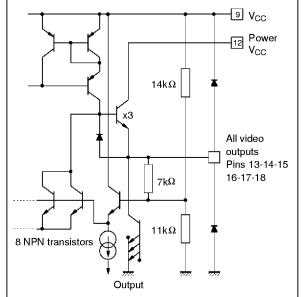


Figure 2: Output Configuration



IN / OUT PIN CONFIGURATION (continued)

Figure 3: Bus I/O Configuration

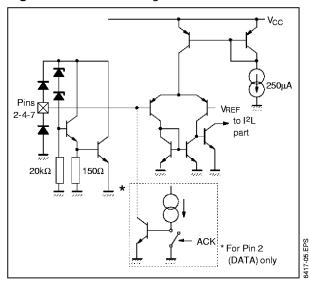
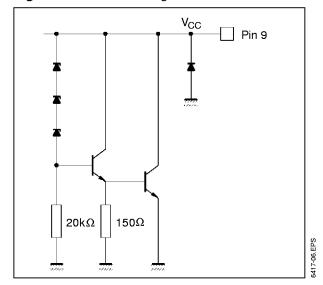


Figure 4: V_{CC} Pin Configuration

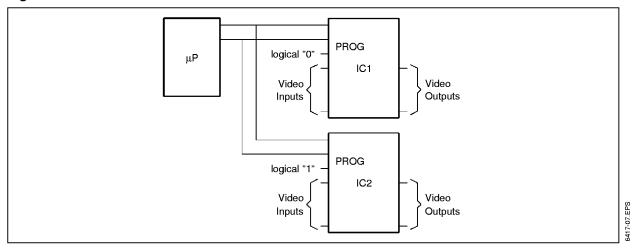


USE WITH AN OTHER TEA6417

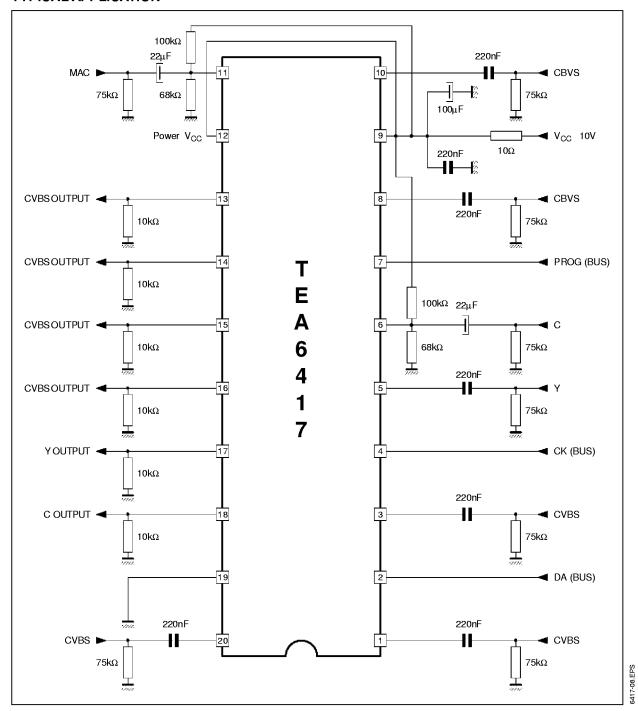
The programmation input (PROG) permits to operate with two TEA6417 in parallel and to select them independently through the I²C-BUS without modi-

fying the adress byte. Consequently, the switch capabilities are doubled or IC1 and IC2 can be cascaded.

Figure 5



TYPICAL APPLICATION

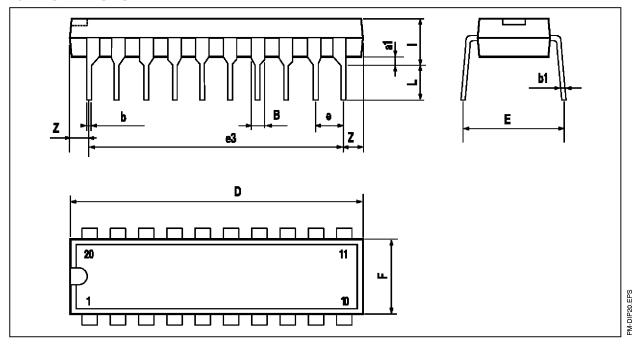


CROSSTALK IMPROVEMENT

When any input is not used, it must be bypassed to ground through a 220nF capacitor.

PACKAGE MECHANICAL DATA

20 PINS - PLASTIC DIP



Dimensions		Millimeters				
	Min.	Тур.	Max.	Min.	Тур.	Max.
a1	0.254			0.010		
В	1.39		1.65	0.055		0.065
b		0.45			0.018	
b1		0.25			0.010	
D			25.4			1.000
E		8.5			0.335	
е		2.54			0.100	
e3		22.86			0.900	
F			7.1			0.280
I			3.93			0.155
L		3.3			0.130	
Z			1.34			0.053

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